

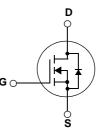
# FDI025N06 N-Channel PowerTrench<sup>®</sup> MOSFET **60V**, **265A**, **2.5m**Ω

# Features

- $R_{DS(on)} = 1.9m\Omega$  (Typ.) @  $V_{GS} = 10V$ ,  $I_D = 75A$
- · Fast switching speed
- · Low gate charge
- High performance trench technology for extremely low R<sub>DS(on)</sub>
- · High power and current handling capability
- · RoHS compliant



**TO-262 FDI Series** 



**General Description** 

Application

maintain superior switching performance.

# **MOSFET Maximum Ratings** $T_C = 25^{\circ}C$ unless otherwise noted

GDS

| Symbol                            | Parameter   |                                      |          | Ratings     | Units |
|-----------------------------------|---|--------------------------------------|----------|-------------|-------|
| V <sub>DSS</sub>                  | Drain to Source Voltage   |                                      |          | 60          | V     |
| V <sub>GSS</sub>                  | Gate to Source Voltage  |                                      |          | ±20         | V     |
| ID                                | Ducia Course at   | -Continuous ( $T_C = 25^{\circ}C$ )  |          | 265*        | Α     |
|                                   | Drain Current   | -Continuous ( $T_C = 100^{\circ}C$ ) |          | 190*        | Α     |
| I <sub>DM</sub>                   | Drain Current   | - Pulsed                             | (Note 1) | 1060        | Α     |
| E <sub>AS</sub>                   | Single Pulsed Avalanche Energy (Note 2)   |                                      | 2531     | mJ          |       |
| dv/dt                             | Peak Diode Recovery dv/dt (Note 3)  |                                      | 3.5      | V/ns        |       |
| P <sub>D</sub>                    | Devues Dississation   | $(T_{C} = 25^{\circ}C)$              |          | 395         | W     |
|                                   | Power Dissipation   | - Derate above 25°C                  |          | 2.6         | W/ºC  |
| T <sub>J</sub> , T <sub>STG</sub> | Operating and Storage Temperature Range   |                                      |          | -55 to +175 | °C    |
| Τ <sub>L</sub>                    | Maximum Lead Temperature for Soldering Purpose,<br>1/8" from Case for 5 Seconds |                                      |          | 300         | °C    |

\*Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 120A.

# **Thermal Characteristics**

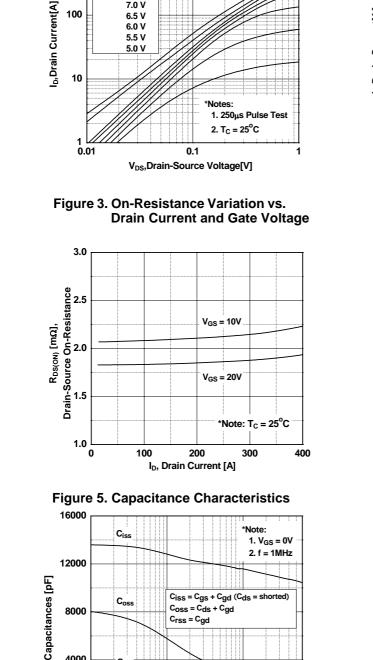
| Symbol              | Parameter                               | Ratings | Units |
|---------------------|---|---------|-------|
| $R_{	ext{	heta}JC}$ | Thermal Resistance, Junction to Case    | 0.38    |       |
| $R_{\theta CS}$     | Thermal Resistance, Case to Sink Typ.   | 0.5     | °C/W  |
| $R_{	ext{	heta}JA}$ | Thermal Resistance, Junction to Ambient | 62.5    |       |

June 2008

| FDI025N06             |
|-----------------------|
| N-Channel             |
| PowerTren             |
| ch <sup>®</sup> MOSFE |

| -  |  | Package Reel   |                                    | Reel Size  | Tape Width   |             |  | Quantity  |  |  |
|--|--|--|------------------------------------|--|--|-------------|--|---|--|--|
|  |  | TO-2   | 62 -                               |  | -  |             | 50   |   |  |  |
| Electric   | al Char  | acteristics  |                                    |  |  |             |  |   |  |  |
| Symbol   |  | Parameter  |                                    |  | Test Condition   | s           | Min.   | Тур.  | Max.   | Unit   |
| Off Chara  | acteristic   | s  |                                    |  |  |             |  |   |  |  |
| BV <sub>DSS</sub>  |  | Drain to Source Breakdown Voltage  |                                    | lp = 25  | I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V, T <sub>C</sub> = 25 <sup>o</sup> C                       |             | 60   | -   | _  | V  |
| ∆BV <sub>DSS</sub>   |  | Breakdown Voltage Temperature<br>Coefficient   |                                    |  |  |             | 00   |   |  |  |
| $\Delta T_{J}$   |  |  |                                    | I <sub>D</sub> = 25  | i0μA, Referenced t   | o 25ºC      | -  | 0.04  | -  | V/°C   |
|  | 7  | ata Malta na Duain Orra  |                                    | V <sub>DS</sub> =  | $V_{DS} = 60V, V_{GS} = 0V$<br>$V_{DS} = 60V, V_{GS} = 0V, T_C = 150^{\circ}C$                         |             | -  | -   | 1  |  |
| IDSS   | Zero Ga  | ate Voltage Drain Cur  | rent                               | $V_{DS} =$   |  |             | -  | -   | 500  | μA   |
| I <sub>GSS</sub>   | Gate to  | Body Leakage Curre   | nt                                 | $V_{GS} =$   | ±20V, V <sub>DS</sub> = 0V   |             | -  | -   | ±100   | nA   |
| On Chara   | acteristic   | s  |                                    |  |  |             |  |   |  |  |
| V <sub>GS(th)</sub>  | -  | nreshold Voltage   |                                    | V <sub>GS</sub> =  | V <sub>DS</sub> , I <sub>D</sub> = 250μA   |             | 2.5  | 3.5   | 4.5  | V  |
| R <sub>DS(on)</sub>  |  | Prain to Source On Re  | sistance                           |  | 10V, I <sub>D</sub> = 75A  |             | -  | 1.9   | 2.5  | mΩ   |
| 9FS  | Forward  | d Transconductance   |                                    |  | 10V, I <sub>D</sub> = 75A  | (Note 4)    | -  | 200   | -  | S  |
| -  |  |  |                                    |  |  |             |  | 11190   | 14885  | nF   |
| C <sub>iss</sub><br>C <sub>oss</sub><br>C <sub>rss</sub>   | Input Ca<br>Output 0<br>Reverse  | apacitance<br>Capacitance<br>e Transfer Capacitanc   | e                                  | — V <sub>DS</sub> =<br>f = 1M  | 25V, V <sub>GS</sub> = 0V<br>Hz  |             | -  | 11190<br>1610<br>750                                | 14885<br>2140<br>1125  | pF<br>pF<br>pF   |
| C <sub>iss</sub><br>C <sub>oss</sub><br>C <sub>rss</sub><br>Q <sub>g(tot)</sub>  | Input Ca<br>Output 0<br>Reverse<br>Total Ga  | apacitance<br>Capacitance<br>e Transfer Capacitanc<br>ate Charge at 10V  | e                                  | f = 1M   | Hz   |             | -  | 1610<br>750<br>174                                  | 2140<br>1125<br>226  | pF<br>pF<br>nC   |
| $\begin{array}{c} C_{iss} \\ C_{oss} \\ C_{rss} \\ Q_{g(tot)} \\ Q_{gs} \end{array}$   | Input Ca<br>Output 0<br>Reverse<br>Total Ga  | apacitance<br>Capacitance<br>e Transfer Capacitanc   | e                                  | f = 1M   | Hz<br>48V, I <sub>D</sub> = 75A  |             |  | 1610<br>750   | 2140<br>1125   | pF<br>pF   |
| $\begin{array}{c} C_{iss} \\ C_{oss} \\ C_{rss} \\ Q_{g(tot)} \\ Q_{gs} \end{array}$   | Input Ca<br>Output 0<br>Reverse<br>Total Ga<br>Gate to   | apacitance<br>Capacitance<br>e Transfer Capacitanc<br>ate Charge at 10V  |                                    | f = 1M   | Hz<br>48V, I <sub>D</sub> = 75A  | (Note 4, 5) | -  | 1610<br>750<br>174                                  | 2140<br>1125<br>226  | pF<br>pF<br>nC   |
| $C_{iss}$ $C_{oss}$ $C_{rss}$ $Q_{g(tot)}$ $Q_{gs}$ $Q_{gd}$   | Input Ca<br>Output 0<br>Reverse<br>Total Ga<br>Gate to<br>Gate to  | apacitance<br>Capacitance<br>e Transfer Capacitanc<br>ate Charge at 10V<br>Source Gate Charge<br>Drain "Miller" Charge   |                                    | f = 1M   | Hz<br>48V, I <sub>D</sub> = 75A  | (Note 4, 5) | -  | 1610<br>750<br>174<br>54                            | 2140<br>1125<br>226<br>-   | pF<br>pF<br>nC<br>nC                                     |
| $C_{iss}$<br>$C_{oss}$<br>$C_{rss}$<br>$Q_{g(tot)}$<br>$Q_{gs}$<br>$Q_{gd}$<br>Switching   | Input Ca<br>Output<br>Reverse<br>Total Ga<br>Gate to<br>Gate to<br>g Charac  | apacitance<br>Capacitance<br>e Transfer Capacitanc<br>ate Charge at 10V<br>Source Gate Charge<br>Drain "Miller" Charge   |                                    | f = 1M   | Hz<br>48V, I <sub>D</sub> = 75A  | (Note 4, 5) | -  | 1610<br>750<br>174<br>54                            | 2140<br>1125<br>226<br>-   | pF<br>pF<br>nC<br>nC                                     |
| C <sub>iss</sub><br>C <sub>oss</sub><br>C <sub>rss</sub><br>Q <sub>g(tot)</sub><br>Q <sub>gs</sub><br>Q <sub>gd</sub><br>Switching   | Input Ca<br>Output of<br>Reverse<br>Total Ga<br>Gate to<br>Gate to<br>g Charac   | apacitance<br>Capacitance<br>e Transfer Capacitanc<br>ate Charge at 10V<br>Source Gate Charge<br>Drain "Miller" Charge<br>teristics  |                                    | $V_{DS} = V_{GS} = V_{DD} = V$ | Hz<br>48V, I <sub>D</sub> = 75A<br>10V<br>30V, I <sub>D</sub> = 75A                                    | (Note 4, 5) | -  | 1610<br>750<br>174<br>54<br>50                      | 2140<br>1125<br>226<br>-<br>-  | pF<br>pF<br>nC<br>nC                                     |
| $\begin{array}{c} C_{iss} \\ C_{oss} \\ C_{rss} \\ Q_{g(tot)} \\ Q_{gs} \\ Q_{gd} \\ \end{array}$  | Input Ca<br>Output 0<br>Reverse<br>Total Ga<br>Gate to<br>Gate to<br><b>g Charac</b><br>Turn-Or<br>Turn-Or   | apacitance<br>Capacitance<br>e Transfer Capacitanc<br>ate Charge at 10V<br>Source Gate Charge<br>Drain "Miller" Charge<br>teristics  |                                    | $V_{DS} = V_{GS} = V_{DD} = V$ | Hz<br>48V, I <sub>D</sub> = 75A<br>10V   | (Note 4, 5) | -  | 1610<br>750<br>174<br>54<br>50<br>134               | 2140<br>1125<br>226<br>-<br>-<br>278                                     | pF<br>pF<br>nC<br>nC<br>nC                               |
| Dynamic<br>$C_{iss}$<br>$C_{oss}$<br>$C_{rss}$<br>$Q_{g(tot)}$<br>$Q_{gs}$<br>$Q_{gd}$<br>Switching<br>$t_{d(on)}$<br>$t_r$<br>$t_{q(off)}$<br>$t_f$   | Input Ca<br>Output 0<br>Reverse<br>Total Ga<br>Gate to<br>Gate to<br><b>g Charac</b><br>Turn-Or<br>Turn-Or   | apacitance<br>Capacitance<br>e Transfer Capacitanc<br>ate Charge at 10V<br>Source Gate Charge<br>Drain "Miller" Charge<br>teristics<br>n Delay Time<br>n Rise Time   |                                    | $V_{DS} = V_{GS} = V_{DD} = V$ | Hz<br>48V, I <sub>D</sub> = 75A<br>10V<br>30V, I <sub>D</sub> = 75A                                    | (Note 4, 5) | -  | 1610<br>750<br>174<br>54<br>50<br>134<br>324        | 2140<br>1125<br>226<br>-<br>-<br>278<br>658                              | pF<br>pF<br>nC<br>nC<br>nC<br>nC                         |
| C <sub>iss</sub><br>C <sub>oss</sub><br>C <sub>rss</sub><br>Q <sub>g(tot)</sub><br>Q <sub>gs</sub><br>Q <sub>gd</sub><br>Switching<br>t <sub>d(on)</sub><br>t <sub>r</sub><br>t <sub>r</sub>   | Input Ca<br>Output 0<br>Reverse<br>Total Ga<br>Gate to<br>Gate to<br><b>g Charac</b><br>Turn-Or<br>Turn-Of<br>Turn-Of  | apacitance<br>Capacitance<br>e Transfer Capacitance<br>ate Charge at 10V<br>Source Gate Charge<br>Drain "Miller" Charge<br>teristics<br>n Delay Time<br>n Rise Time<br>f Delay Time<br>f Fall Time   |                                    | $V_{DS} = V_{GS} = V_{DD} = V$ | Hz<br>48V, I <sub>D</sub> = 75A<br>10V<br>30V, I <sub>D</sub> = 75A                                    |             | -<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-      | 1610<br>750<br>174<br>54<br>50<br>134<br>324<br>348 | 2140<br>1125<br>226<br>-<br>-<br>278<br>658<br>706                       | pF<br>pF<br>nC<br>nC<br>nC<br>nC<br>nS<br>ns             |
| C <sub>iss</sub><br>C <sub>oss</sub><br>C <sub>rss</sub><br>Q <sub>g(tot)</sub><br>Q <sub>gs</sub><br>Q <sub>gd</sub><br>Switching<br>t <sub>d(on)</sub><br>t <sub>r</sub><br>t <sub>d(off)</sub><br>t <sub>f</sub><br>Drain-So  | Input Ca<br>Output 0<br>Reverse<br>Total Ga<br>Gate to<br>Gate to<br><b>g Charac</b><br>Turn-Or<br>Turn-Of<br>Turn-Off   | apacitance<br>Capacitance<br>e Transfer Capacitanc<br>ate Charge at 10V<br>Source Gate Charge<br>Drain "Miller" Charge<br>teristics<br>n Delay Time<br>n Rise Time<br>f Delay Time   |                                    | $V_{DS} = V_{GS} = V$ | Hz<br>48V, I <sub>D</sub> = 75A<br>10V<br>30V, I <sub>D</sub> = 75A<br>10V, R <sub>GEN</sub> = 25Ω     |             | -<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-      | 1610<br>750<br>174<br>54<br>50<br>134<br>324<br>348 | 2140<br>1125<br>226<br>-<br>-<br>278<br>658<br>706                       | pF<br>pF<br>nC<br>nC<br>nC<br>nC<br>nS<br>ns             |
| $C_{iss}$ $C_{coss}$ $C_{rss}$ $Q_{g(tot)}$ $Q_{gs}$ $Q_{gd}$ $Switching$ $t_{d(on)}$ $t_{r}$ $t_{d(off)}$ $t_{f}$ $Drain-Souther the second $ | Input Ca<br>Output 0<br>Reverse<br>Total Ga<br>Gate to<br>Gate to<br><b>g Charac</b><br>Turn-Or<br>Turn-Of<br>Turn-Off<br><b>urn-Off</b>   | apacitance<br>Capacitance<br>e Transfer Capacitance<br>ate Charge at 10V<br>Source Gate Charge<br>Drain "Miller" Charge<br>teristics<br>n Delay Time<br>f Delay Time<br>f Delay Time<br>f Fall Time<br>de Characteristic   | <b>CS</b><br>o Source Did          | $V_{DS} = V_{GS} = V_{GS} = V_{GS} = V_{GS} = 0$   | Hz<br>$48V, I_D = 75A$<br>10V<br>$30V, I_D = 75A$<br>$10V, R_{GEN} = 25\Omega$<br>rd Current           |             | -<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-      | 1610<br>750<br>174<br>54<br>50<br>134<br>324<br>348 | 2140<br>1125<br>226<br>-<br>-<br>278<br>658<br>706<br>510                | pF<br>pF<br>nC<br>nC<br>nC<br>nC<br>nS<br>ns             |
| C <sub>iss</sub><br>C <sub>oss</sub><br>C <sub>rss</sub><br>Q <sub>g(tot)</sub><br>Q <sub>gs</sub><br>Q <sub>gd</sub><br>Switching<br>t <sub>d(on)</sub><br>t <sub>r</sub><br>t <sub>d(off)</sub><br>t <sub>f</sub><br>Drain-Sou<br>I <sub>s</sub><br>I <sub>s</sub>   | Input Ca<br>Output C<br>Reverse<br>Total Ga<br>Gate to<br>Gate to<br><b>g Charac</b><br>Turn-Or<br>Turn-Of<br>Turn-Off<br><b>urn-Off</b><br><b>urce Dioc</b><br>Maximu<br>Maximu   | apacitance<br>Capacitance<br>e Transfer Capacitance<br>ate Charge at 10V<br>Source Gate Charge<br>Drain "Miller" Charge<br>teristics<br>n Delay Time<br>n Rise Time<br>f Delay Time<br>f Delay Time<br>f Fall Time<br>de Characteristic<br>m Continuous Drain t          | CS<br>o Source Dic<br>urce Diode F | $V_{DS} = V_{GS} = V_{GS} = V_{GS} = V_{GS} = 0$   | Hz<br>48V, $I_D = 75A$<br>10V<br>30V, $I_D = 75A$<br>10V, $R_{GEN} = 25\Omega$<br>rd Current<br>urrent |             | -<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-      | 1610<br>750<br>174<br>54<br>50<br>134<br>324<br>348 | 2140<br>1125<br>226<br>-<br>-<br>278<br>658<br>706<br>510<br>265         | pF<br>pF<br>nC<br>nC<br>nC<br>nC<br>nS<br>ns<br>ns<br>ns |
| $C_{iss}$ $C_{coss}$ $C_{rss}$ $Q_{g(tot)}$ $Q_{gs}$ $Q_{gd}$ $Switching$ $t_{d(on)}$ $t_{r}$ $t_{d(off)}$ $t_{f}$ $Drain-Souther the second $ | Input Ca<br>Output C<br>Reverse<br>Total Ga<br>Gate to<br>Gate to<br><b>g Charac</b><br>Turn-Or<br>Turn-Of<br>Turn-Of<br><b>urn-Of</b><br><b>urn-Of</b><br><b>urn-Of</b><br><b>urn-Of</b><br><b>urn-Of</b><br><b>urn-Of</b><br><b>urn-Of</b> | apacitance<br>Capacitance<br>e Transfer Capacitance<br>ate Charge at 10V<br>Source Gate Charge<br>Drain "Miller" Charge<br>teristics<br>n Delay Time<br>f Delay Time<br>f Delay Time<br>f Fall Time<br>de Characteristic<br>m Continuous Drain t<br>m Pulsed Drain to So | CS<br>o Source Dic<br>urce Diode F | $V_{DS} = V_{GS} = V_{GS} = V_{GS} = V_{GS} = V_{GS} = 0$  | Hz<br>$48V, I_D = 75A$<br>10V<br>$30V, I_D = 75A$<br>$10V, R_{GEN} = 25\Omega$<br>rd Current           |             | -<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>- | 1610<br>750<br>174<br>54<br>50<br>134<br>324<br>348 | 2140<br>1125<br>226<br>-<br>-<br>278<br>658<br>706<br>510<br>265<br>1060 | PF<br>pF<br>nC<br>nC<br>nC<br>nS<br>ns<br>ns<br>A<br>A   |

3: I<sub>SD</sub> ≤ /5A, di/dt ≤ 200A/µs, V<sub>DD</sub> ≤ BV<sub>DSS</sub>, Starting I<sub>J</sub> = 25°C
4: Pulse Test: Pulse width ≤ 300µs, Duty Cycle ≤ 2%
5: Essentially Independent of Operating Temperature Typical Characteristics



**Typical Performance Characteristics** 

700

100

V<sub>GS</sub> = 15.0 V

10.0 V

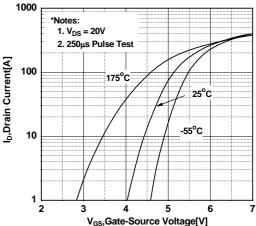
8.0 V

7.0 V

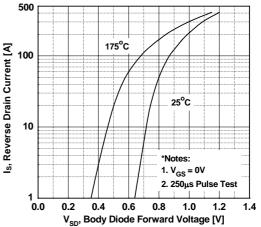
6.5 V

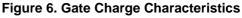
**Figure 1. On-Region Characteristics** 

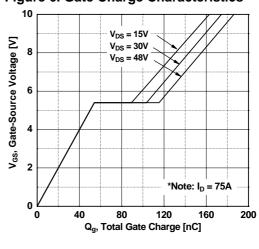
## **Figure 2. Transfer Characteristics**



### Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature







4000

0 └ 0.1

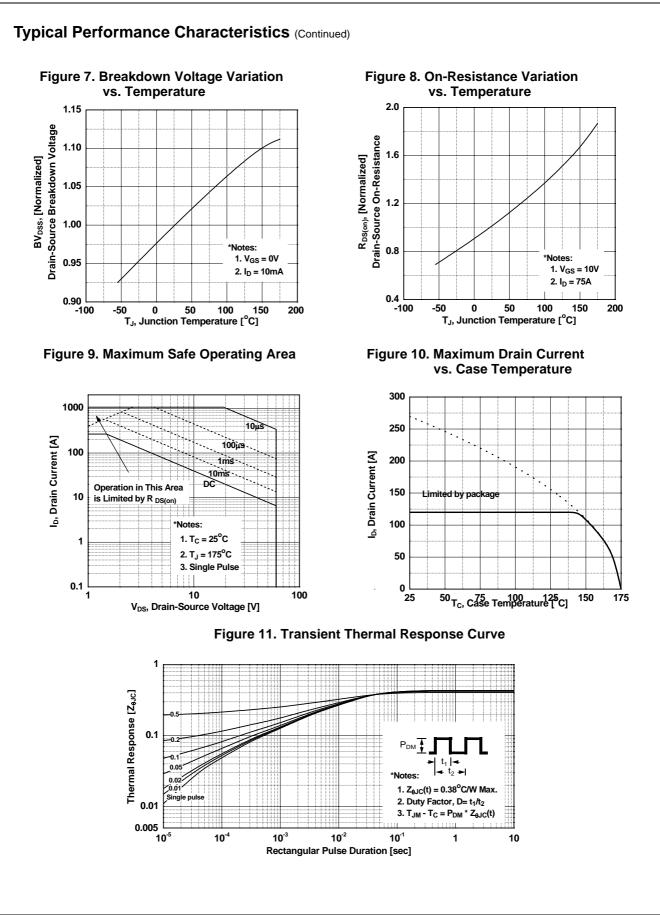
Crss

1

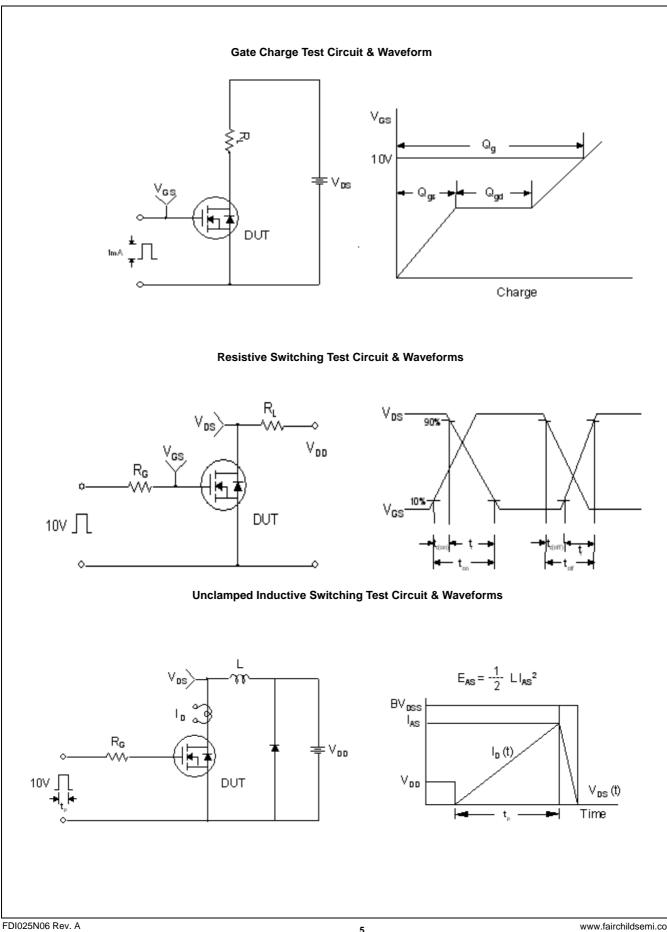
V<sub>DS</sub>, Drain-Source Voltage [V]

10

60

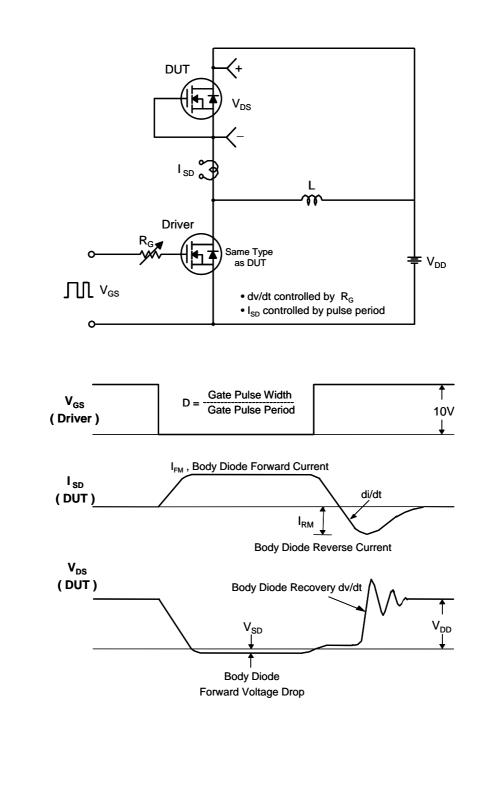


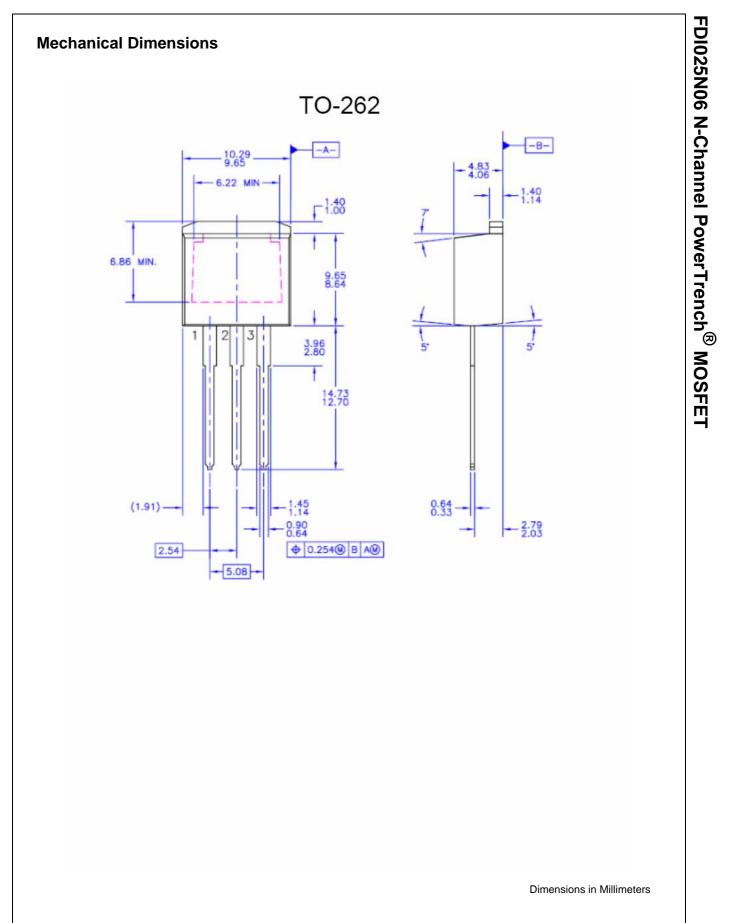
FDI025N06 N-Channel PowerTrench<sup>®</sup> MOSFET



FDI025N06 N-Channel PowerTrench<sup>®</sup> MOSFET

#### Peak Diode Recovery dv/dt Test Circuit & Waveforms







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| L-2.                                 | MicroFET™                           | SPM <sup>®</sup>                | U                      |
| F                                    | MicroPak™                           | STEALTH™                        | SerDes                 |
| Fairchild <sup>®</sup>               | MillerDrive™                        | SuperFET™                       | UHC®                   |
| Fairchild Semiconductor <sup>®</sup> | MotionMax™                          | SuperSOT™-3                     | Ultra FRFET            |
| FACT Quiet Series™                   | Motion-SPM <sup>™</sup>             | SuperSOT™-6                     | UniFET™                |
| FACT®                                | OPTOLOGIC®                          | SuperSOT™-8                     | VCX™                   |
| FAST®                                | OPTOPLANAR®                         | SuperMOS™                       | VisualMax™             |
| FastvCore™                           | U®                                  |                                 |                        |
| FlashWriter <sup>®</sup> *           |                                     |                                 |                        |

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